



Ai-WB2-13U Specification

- Version V1.1.1
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Document resume

Version	Date	Develop/revise content	Edition	Approve
V1.1.0	2022.6.20	First Edition	NanNan Yuan	NingGuan
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1. Product Overview

Ai-WB2-13U is a Wi-Fi&BT module developed by Shenzhen Ai-Thinker Technology Co., LTD. The module is equipped with BL602 chip as the core processor and supports Wi-Fi 802.11b/ g/n protocol and BLE 5.0 protocol. The BL602 chip has a low-power 32-bit RISC CPU, 276KB RAM, and a wealth of peripheral interfaces, including SDIO, SPI, UART, I2C, IR Remote, PWM, ADC, DAC, PIR and GPIO etc. It can be widely used in Internet of Things (IoT), mobile devices, wearable electronic devices, smart home and other fields.

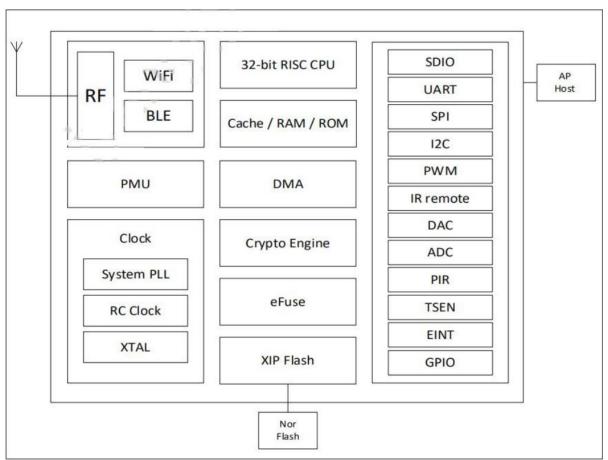


Figure 1 Main chip block diagram



1.1. Characteristic

- The package is SMD-18
- Support IEEE 802.11 b/g/n protocol
- Wi-Fi Security Support WPS/WEP/WPA/WPA2 Personal/WPA2 Enterprise/WPA3
- Support 20MHz bandwidth and Max rate is 72.2 Mbps
- Bluetooth BLE 5.0, Bluetooth Mesh
- Support Station + BLE mode、 Station + SoftAP + BLE mode
- Support 32-bit RISC CPU, 276KB RAM
- Secure start-up, supports mirroring with ECC-256 signature
- Support QSPI/SPI Flash On-The-Fly AES Decryption, support AES 128 CTR mode
- Support AES 128/192/256-bit encryption engine
- Support SHA-1/224/256
- Support true Random number generator (TRNG)
- Public key Accelerator (PKA), support large number basic operations, software provides signature, verification and other application program interface
- Support SDIO, SPI, UART, I2C, IR remote, PWM, ADC, DAC, PIR, GPIO etc
- Integrated Wi-Fi MAC/BB/RF/PA/LNA/BT
- Support a variety of sleep modes, deep sleep current 12µA
- Universal AT instruction for quick start
- Support secondary development, integrated Windows, Linux development environment



2. Main parameters

Model	Ai-WB2-13U		
Package	SMD-18		
Size	14.0*18.0*3.1(±0.2)mm		
Antenna	IPEX connector		
Frequency	2400 ~ 2483.5MHz		
Operating temperature -40°C ~ 85°C			
Storage temperature	-40°C ~ 125°C, < 90%RH		
Power supply	Support voltage 2.7V ~ 3.6V, supply current \geq 500mA		
Interface	UART/GPIO/ADC/PWM/I2C/SPI		
ΙΟ	11		
UART rate	Default 115200 bps		
Security	WPS/WEP/WPA/WPA2 Personal/WPA2 Enterprise/WPA3		
Flash Default 4MByte,Support expansion			

Table 1 Description of the main parameters

2.1. Static electricity requirement

Ai-WB2-13U is an electrostatic sensitive device. Therefore, you need to take special precautions when carrying it.



Figure 2 ESD preventive measures



2.2. Electrical characteristics

Table 2 Electrical	characteristics table
---------------------------	-----------------------

Pa	rameters	Condition	Min. Typical value		Max.	Unit
Volta	age Supply	VDD	2.7	3.3	3.6	V
	VIL	-	-	-	0.3*VDDIO	V
	VIH	-	0.7*VDDIO	-	-	V
I/O	VOL	-	-	0.1*VDDIO	-	V
	VOH	-	-	0.9*VDDIO	-	V
	IMAX	-	-	-	15	mA

2.3. Wi-Fi RF Performance

Table 3 Wi-Fi RF performance table

Description		Unit			
Frequency range	24	MHz			
	Output Pov	ver			
Mode	Min.	Typical value	Max.	Unit	
11n Mode HT20, PA output power	-	16	-	dBm	
11g Mode, PA output power	-	17	-	dBm	
11b Mode, PA output power	-	19	-	dBm	
Receive Sensitivity					
Mode	Min.	Typical value	Max.	Unit	
11b, 1 Mbps	-	-98	-	dBm	
11b, 11 Mbps	-	-90	-	dBm	
11g, 6 Mbps	-	-93	-	dBm	
11g, 54 Mbps	-	-76	-	dBm	
11n, HT20 (MCS7)	-	-73	-	dBm	



2.4. BLE RF Performance

Description		Unit		
Frequency range	24	MHz		
Output Power				
Rate Mode	Min.	Typical value	Max.	Unit
1Mbps	-	9	15	dBm
Receive Sensitivity				
Rate Mode	Min.	Typical value	Max.	Unit
1Mbps sensitivity@30.8%PER	-	-96	_	dBm

Table 4 BLE RF performance table

2.5. Power

The following power consumption data are based on a 3.3V power supply, 25°C ambient temperature, and measured using an internal voltage regulator.

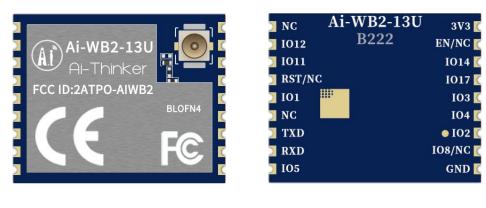
- All measurements are made at the antenna interface with a filter.
- All transmission data are based on 100% duty cycle in continuous transmission mode.

 Table 5 Power consumption table

Mode	Min.	AVG	Max.	Unit
Tx 802.11b, 11Mbps, POUT=+21dBm	-	260	-	mA
Tx 802.11g, 54Mbps, POUT =+18dBm	-	245	-	mA
Tx 802.11n, MCS7, POUT =+17dBm	-	230	-	mA
Rx 802.11b,packet length 1024 byte	-	65	-	mA
Rx 802.11g,packet length 1024 byte	-	65	-	mA
Rx 802.11n,Packet length 1024 byte	-	65	-	mA
Deep-Sleep	-	12	-	μΑ



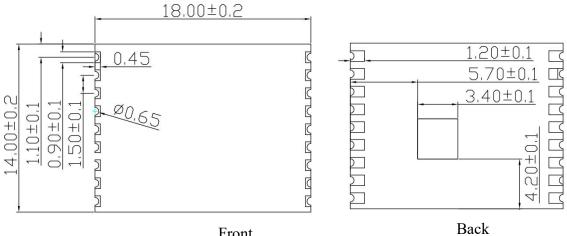
3. Appearance Dimensions



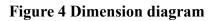
Front

Back

Figure 3 Appearance diagram (Rendering figure is for reference only, subject to physical objects)



Front





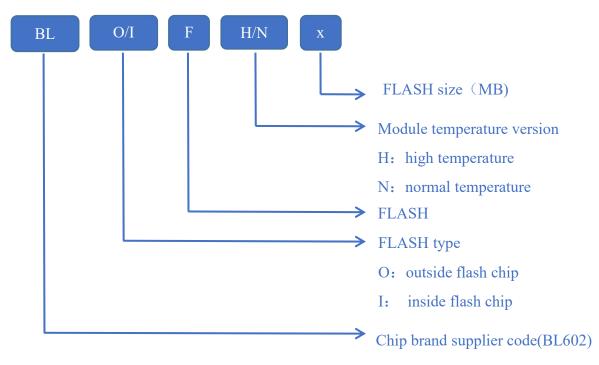


Figure 5 Shield printing information

4. Pin Definition

Ai-WB2-13U module is connected with a total of 18 pins, as shown in the pin schematic diagram, pin function definition table is the interface definition.

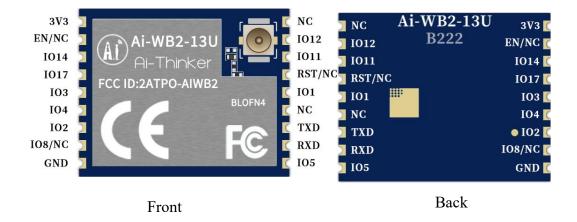


Figure 6 Schematic diagram of module pins



Table 6 Pin function definition table

Function
3.3V power supply; It is recommended that the output current of the external power supply be higher than 500mA
Default chip enable pin, active-high, cannot be used with RST at the same time
GPIO14/SPI_SS/IIC_SCL/PWM_CH4/ADC_CH2
GPIO17/SPI_MOSI/MISO/IIC_SDA/PWM_CH2
GPIO3/SPI_SCLK/IIC_SDA/PWM_CH3
GPIO4/SPI_MOSI/MISO/IIC_SCL/PWM_CH4/ADC_CH4
It is not recommended to use. It is shared with the Flash in the module. If you need to use it, please contact Ai-Thinker.GPIO2/SPI_SS/IIC_SCL/PWM_CH2
NC, unavailable. If you need to use it, please contact Ai-Thinker. Bootstrap/GPIO8/SPI_MOSI/MISO/IIC_SCL/PWM_CH3
Ground
GPIO5/SPI_MOSI/MISO/IIC_SDA/PWM_CH0/ADC_CH4
RXD/GPIO7/SPI_SCLK/IIC_SDA/PWM_CH2
TXD/GPIO16/SPI_MOSI/MISO/IIC_SCL/PWM_CH1
NC
It is not recommended to use. It is shared with the Flash in the module. If you need to use it, please contact Ai-Thinker.GPIO1/SPI_MOSI/MISO/IIC_SDA/PWM_CH1
Default not connect, can be customized to reset pin, active-low, if you need to use it, please contact Ai-Thinker
GPIO11/SPI_SCLK/IIC_SDA/ADC_CH10
GPIO12/SPI_MOSI/MISO/IIC_SCL/PWM_CH2/ADC_CH0
NC

1.At the moment of power-on, if Bootstrap GPIO8 is high, the module enters the programming mode; if Bootstrap GPIO8 is low, the module starts normally.



5. Schematic

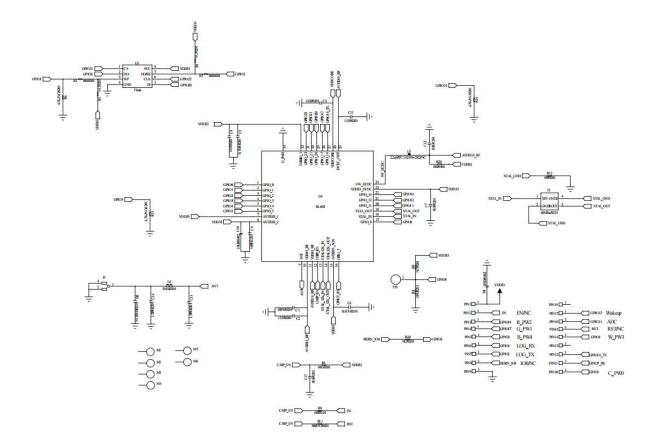


Figure 7 Module schematic



6. Design Guidance

6.1. Application circuit

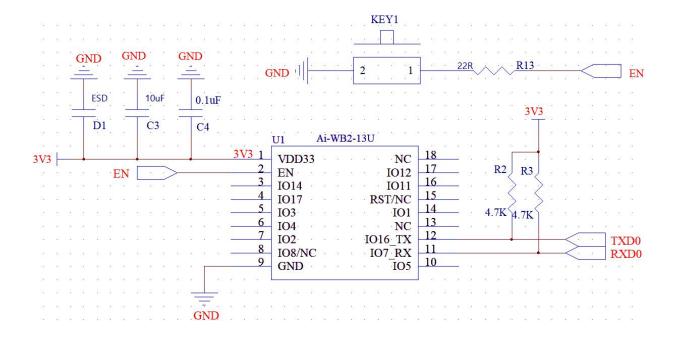


Figure 8 Application circuit diagram

- If the IO port is used as PWM, it is recommended to reserve a 4.7K pull-down resistor around the module. Especially in the application of light control, it can prevent the flashing light phenomenon at the moment of power-on start.
- The IO1/IO2/IO8/NC/RST/NC pins, which are not available by default. If you need to use it, please contact Ai-Thinker.



6.2. Recommend PCB footprint size

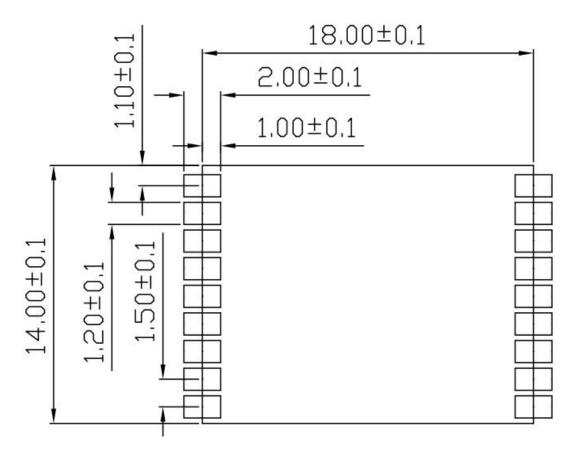


Figure 9 Recommend PCB footprint size

6.3. Antenna layout requirements

The following two methods are recommended for the installation position on the mainboard:

Option 1: put the module on the edge of the motherboard, and the antenna area extends out of the edge of the motherboard.

Option : put the module on the edge of the motherboard, the edge of the motherboard at the antenna position hollowed out an area.

In order to meet the performance of onboard antenna, it is forbidden to place metal parts around the antenna and keep away from high frequency devices.



6.4. Power supply

- Recommended 3.3V voltage, peak current over 500mA.
- Power supply is recommend to use LDO; if the DC-DC is used, the ripple is recommended to be controlled within 30mV
- DC-DC power supply circuit proposes to reserve the dynamic response capacitance to optimize the output ripple with large load changes.
- It is recommended to add ESD devices to the 3.3V power interface.

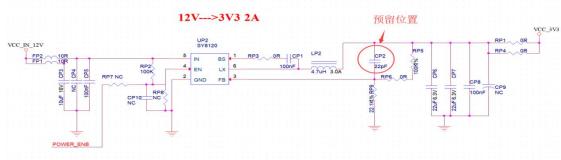


Figure 10 DC-DC step-down circuit diagram



6.5. GPIO

- There are some IO ports on the periphery of the module. If you need to use it, it is recommended to connect a 10-100 ohm resistor in series with the IO port. This inhibits overshoot and makes both sides level more stable. It is helpful for EMI and ESD.
- For special I/O ports to be pulled up and down, refer to the direction for use in the specifications, which may affect the module start-up configuration.
- The IO port of the module is 3.3V. If the IO level of the main control and the module do not match, a level convert circuit needs to be added.
- If the I/O port is directly connected to a peripheral port or terminals, for example, a pin row, reserve an ESD device near the terminal of the I/O cable.

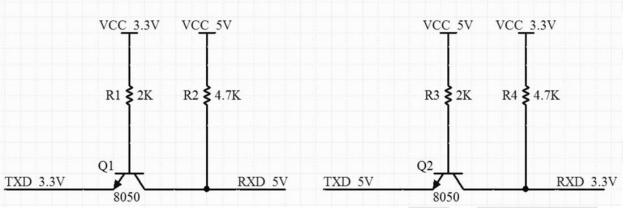


Figure 11 Level convert circuit



7. Storage conditions

Products sealed in moisture-proof bags should be stored in a non-condensing atmosphere of $<40 \circ C /90\%$ RH.

The module has a moisture sensitivity rating of MSL 3.

After the vacuum bag is opened, it must be used within 168 hours at $25\pm5^{\circ}C/60\%$ RH, otherwise it needs to be baked before it can be put on line again.

(O°) 度 赒 峰值温度 235 ~ 250°C 250 预热恒温区 回流区 冷却区 -1 ~ -5°C/s 60 ~ 120s >217°C 60~90s 150 ~ 200°C 217 200 焊接时间 > 30s 升温区 1~3°C/s 100 50 25 时间 (s) 0 50 100 150 200 250 0 升温区 - 温度: 25~150°C 时间: 60~90s 升温斜率: 1~3°C/s 预热恒温区 — 温度: 150~200°C 时间: 60~120s 回流焊接区 - 温度: >217°C 时间: 60~90s; 峰值温度: 235~250°C 时间: 30~70s 冷却区 - 温度: 峰值温度~180°C 降温斜率-1~-5°C/s 焊料 - 锡银铜合金无铅焊料 (SAC305)

8. Reflow welding curve diagram

Figure 12 Reflow welding diagram



9. Product Packaging Information

Ai-WB2-13U module was packaged in a tape, 800pcs/reel. As shown in the below image:



Figure 13 Package and packing diagram

10.Contact us

Ai-Thinker official website

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Office forum

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WeChat mini program



WeChat official account



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